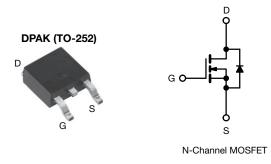
# SiHD240N60E

**Vishay Siliconix** 



# **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.208			
Q <sub>g</sub> max. (nC)	23				
Q <sub>gs</sub> (nC)	4				
Q <sub>gd</sub> (nC)	6				
Configuration	Single				

#### FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	DPAK (TO-252)			
Lead (Pb)-free and halogen-free	SiHD240N60E-GE3			

ABSOLUTE MAXIMUM RATINGS	$(1_{\rm C} = 25^{-1} \rm C, un)$	less otherwis	se noted)				
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V <sub>DS</sub>	600	v		
Gate-source voltage			V <sub>GS</sub>	± 30	v		
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	1-	12			
	VGS AL TO V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	7	A		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	30			
Linear derating factor				0.63	W/°C		
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	81	mJ		
Maximum power dissipation			PD	78	W		
Operating junction and storage temperature ra	nge		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope		T <sub>J</sub> = 125 °C	dy /dt	70	V/ns		
Reverse diode dv/dt d			dv/dt 28		V/IS		
Soldering recommendations (peak temperature	e) <sup>c</sup>	For 10 s		260	°C		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 2.4 A
- c. 1.6 mm from case
- d.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting  $T_J$  = 25 °C



COMPLIANT

HALOGEN

FREE



Vishay Siliconix

PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-		62				
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	- 1.6			- °C/W		
	•							
SPECIFICATIONS ( $T_J = 25 \ ^{\circ}C$ ,	unless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDIT	ONS	MIN.	TYP.	MAX.	UNI
Static		•				•		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	50 µA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.63	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 μA	3.0	-	5.0	V
		,	$V_{GS} = \pm 20 V$ $V_{GS} = \pm 30 V$		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,			- 1	-	± 1	μA
7		V <sub>DS</sub> =	= 600 V, V <sub>GS</sub>	s = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub>	= 5.5 A	-	0.208	0.240	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$		-	4	-	S	
Dynamic		•			•	•	•	
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ $f = 1 MHz$ $V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	783	-	pF	
Output capacitance	C <sub>oss</sub>			-	50	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	5	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>			-	32	-		
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	187	-		
Total gate charge	Qg	V <sub>GS</sub> = 10 V I <sub>D</sub> = 5.5 A, V <sub>DS</sub> = 480 V		-	15	23	nC	
Gate-source charge	Q <sub>gs</sub>			-	4	-		
Gate-drain charge	Q <sub>gd</sub>				-	6	-	1
Turn-on delay time	t <sub>d(on)</sub>			-	15	30		
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	$V_{DD}$ = 480 V, I <sub>D</sub> = 5.5 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 9.1 Ω		-	14	28	- ns
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =			-	26	52	
Fall time	t <sub>f</sub>	1		-	14	28	1	
Gate input resistance	Rg	f = 1 MHz, open drain		0.8	1.5	3.0	Ω	
Drain-Source Body Diode Characteris	tics	•			•	•	•	
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12	A	
Pulsed diode forward current	I <sub>SM</sub>			-	-	30		
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 5.5 A, V <sub>GS</sub> = 0 V			-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C, } I_{F} = I_{S} = 5.5 \text{ A,}$ di/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	209	418	ns	
Reverse recovery charge	Q <sub>rr</sub>			-	2.1	4.2	μC	
Reverse recovery current	I <sub>RRM</sub>			-	18	-	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

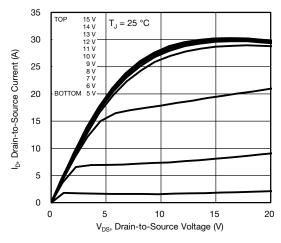


Fig. 1 - Typical Output Characteristics

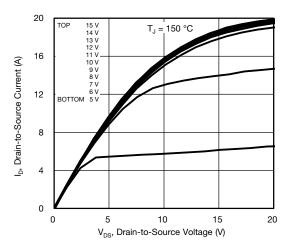


Fig. 2 - Typical Output Characteristics

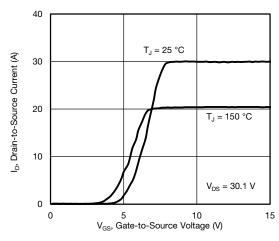


Fig. 3 - Typical Transfer Characteristics

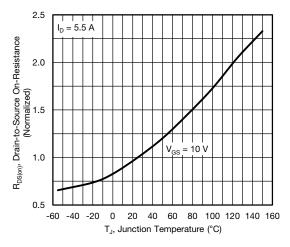


Fig. 4 - Normalized On-Resistance vs. Temperature

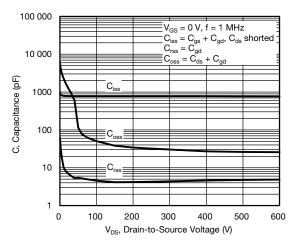


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

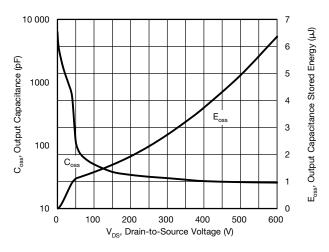


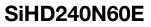
Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 

#### S18-0764-Rev. A, 30-Jul-2018

**3** For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 92100

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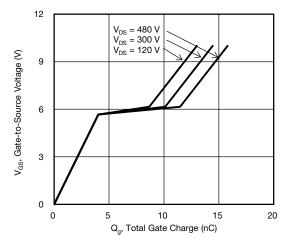


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

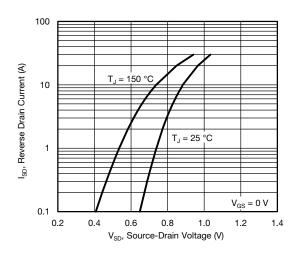


Fig. 8 - Typical Source-Drain Diode Forward Voltage

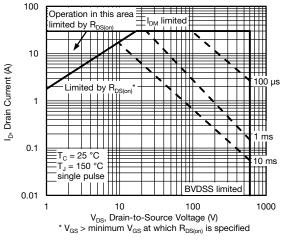


Fig. 9 - Maximum Safe Operating Area

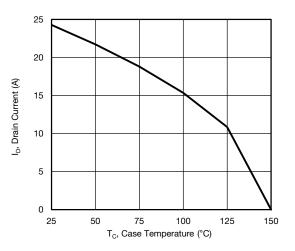


Fig. 10 - Maximum Drain Current vs. Case Temperature

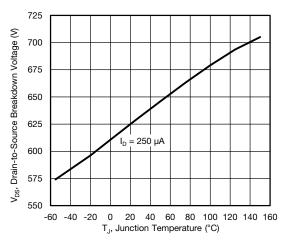


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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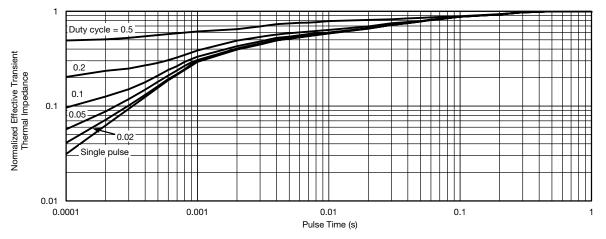


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

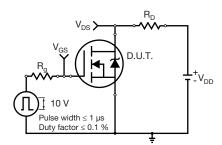


Fig. 13 - Switching Time Test Circuit

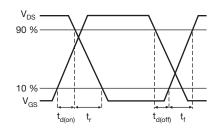


Fig. 14 - Switching Time Waveforms

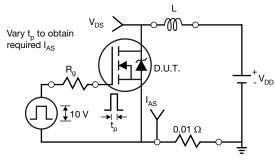


Fig. 15 - Unclamped Inductive Test Circuit

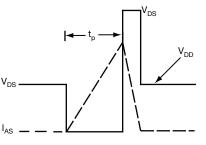


Fig. 16 - Unclamped Inductive Waveforms

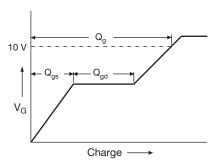


Fig. 17 - Basic Gate Charge Waveform

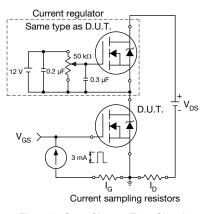
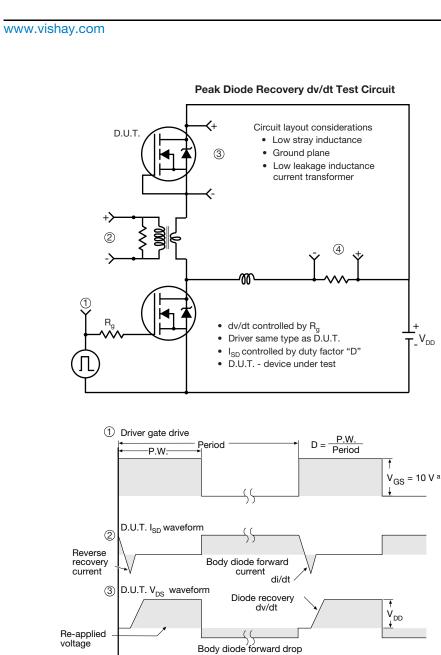


Fig. 18 - Gate Charge Test Circuit

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Inductor current

4

Note

# SiHD240N60E

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Fig. 19 - For N-Channel

Ripple ≤ 5 %

a.  $V_{GS} = 5$  V for logic level devices

↑ I<sub>SD</sub>

SHA

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